

**Application for the scholarship "Engineering**  
**studies with world market leaders" at Heilbronn**  
**University, Reinhold-Würth-Hochschule Künzelsau**  
**Campus**

The scholarship "Engineering studies with the world market leaders" at Heilbronn University, Reinhold-Würth-Hochschule Künzelsau Campus is aimed at first-year students in the following degree programmes at the Faculty of Engineering and Business: B.Sc. in Automation Technology and Electrical Engineering, B.Sc. in Electrical Engineering, B.Eng. Industrial Engineering and Management and B.Eng. Energy System Engineering and Management (English-taught).

To apply for funding as a first-year student in the 1st and 2nd semester, please fill out the application form completely and legibly and send it together with the required documents (see information sheet) in **one** PDF file to: <mailto:susanne.paschke@hs-heilbronn.de>

The fields marked with an asterisk (\*) are mandatory.

**Personal data**

First name\* \_\_\_\_\_

Name\* \_\_\_\_\_

Date of birth\* \_\_\_\_\_

Nationality \_\_\_\_\_

Gender       female       male       diverse

**Semester address (if already available)**

Street, house number\* \_\_\_\_\_

Addition (room, floor if applicable)\* \_\_\_\_\_

POSTCODE\* \_\_\_\_\_

Place\* \_\_\_\_\_

E-mail address\* \_\_\_\_\_

Telephone number \_\_\_\_\_

**Home address (if different from semester address or semester address does not yet exist\*)**

Street, house number \* \_\_\_\_\_

Addition (room, floor, if applicable) \_\_\_\_\_

POSTCODE\* \_\_\_\_\_

Place\* \_\_\_\_\_

E-mail address\* \_\_\_\_\_

Telephone number \_\_\_\_\_

**Send notification of authorisation to\***

Semester address

Home address

E-mail address

### **Study details**

Matriculation number (if already available) \* \_\_\_\_\_

Study programme\* \_\_\_\_\_

### **Explanation**

I hereby confirm that the information I have provided is complete and correct. I am aware that any deliberately false or incomplete answers to individual questions will invalidate the award of the scholarship and result in an obligation to repay any payments already made.

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Place, date

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Signature

### **Declaration of consent to the processing of personal data**

- (1) I expressly consent to my application documents being processed by Heilbronn University of Applied Sciences as part of the selection procedure for a scholarship "Technology studies with world market leaders".
- (2) Furthermore, I am aware that other members of the university and, if applicable, representatives of private sponsors will be involved in the selection of scholarship holders and will receive my application documents. Any commercial use of my data is excluded.
- (3) I agree that my data will be stored by Heilbronn University for six years after the end of the scholarship.
- (4) In the event that my application is unsuccessful, my application documents will be deleted by Heilbronn University and the parties involved in the selection process after completion of the selection procedure.

application process. Only the applicant's name, degree programme, application semester and address will be stored by Heilbronn University for one year.

(5) This consent is voluntary. However, if consent is not given or is withdrawn, the scholarship applied for cannot be granted.

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Place, date

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Signature

### **Declaration of participation**

(1) If my application is successful, I hereby declare my participation in the scholarship for "Engineering studies with the world market leaders". I agree that if I am awarded a scholarship, my academic progress after the 1st semester and 2nd semester will be checked by Reinhold-Würth-Hochschule Künzelsau Campus. For this purpose, I will send the scholarship office ([stipendienstelle@hs-heilbronn.de](mailto:stipendienstelle@hs-heilbronn.de)) a transcript of records and a certificate of enrolment after re-registration for the 2nd and 3rd semesters. The notification of approval for the scholarship specifies the date by which these documents must be submitted.

(2) Furthermore, I agree to participate in the accompanying programme. The aim of the support programme is for the scholarship holders to get involved in joint activities at the Künzelsau campus in order to strengthen the social community and networking between students. Further aims are to support the recruitment of new students and to establish contacts with Hohenlohe companies. I understand that regular active participation in the social programme is a prerequisite for receiving the scholarship.

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Place, date

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Signature

### **Notes on data protection**

Responsible for the processing of personal data is the

Heilbronn University - Corporation under public law Represented by  
the Rector Prof. Dr.-Ing.

Max-Planck-Str. 39, 74081 Heilbronn, Germany

Phone: 07131 / 504-0

E-mail: [dsb@hs-heilbronn.de](mailto:dsb@hs-heilbronn.de)

The personal data collected with this application and during the funding period will be used for the selection procedure and to implement the scholarship.

"Technology studies with the world market leaders" and stored. This processing takes place with your consent and is based on the legal basis of Art. 6 para. 1 letter a GDPR.

You have the right,

- to request information about your personal data processed by us in accordance with Art. 15 EU-DSGVO;
- in accordance with Art. 16 EU-DSGVO, to immediately request the correction of incorrect or incomplete personal data stored by us;
- to request the deletion of your personal data stored by us in accordance with Art. 17 EU-DSGVO;
- to request the restriction of the processing of your personal data in accordance with Art. 18 EU-DSGVO;
- in accordance with Art. 20 EU-DSGVO, to receive your personal data that you have provided to us in a structured, commonly used and machine-readable format or to request that it be transmitted to another controller and
- to lodge a complaint with a supervisory authority in accordance with Art. 77 EU-DSGVO.